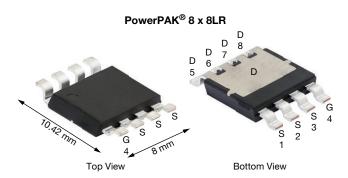
SQJQ118ER

www.vishay.com

Vishay Siliconix

Automotive N-Channel 100 V (D-S) 175 °C MOSFET



FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Thin 1.9 mm height
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

N-Channel MOSFET

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PRODUCT SUMMARY			
V _{DS} (V)	100		
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0036		
I _D (A) ^e	105		
Configuration	Single		

ORDERING INFORMATION	
Package	PowerPAK 8 x 8LR
Lead (Pb)-free and halogen-free	SQJQ118ER (for detailed order number please see <u>www.vishay.com/doc?79776</u>)

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	100	V	
Gate-source voltage		V _{GS}	± 20		
Continuous drain current ^e	T _C = 25 °C	1_	105		
	T _C = 125 °C		61		
Continuous source current (diode conduction) e		ا _S	97	А	
Pulsed drain current ^{a, e}		I _{DM}	423		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	55		
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	151	mJ	
Maximum power dissipation ^{c, e}	T _C = 25 °C	р	107	- W	
	T _C = 125 °C	P _D	35		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperature) ^c			260	C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^b	R _{thJA}	40	°C/W	
Junction-to-case (drain) ^d	ction-to-case (drain) ^d		1.4	0/10	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. When mounted on 1" square PCB (FR4 material)

c. See solder profile (www.vishay.com/doc?73257). The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

d. As per JESD51-14

e. Values based on R_{thJC} and T_C of 25 °C. Actual values achievable will be dependent on the thermal characteristics of the complete system 1

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SPECIFICATIONS ($T_C = 25 \text{ °C}$, unless otherwise noted)								
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT		
Static								
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0, I_D = 250 \ \mu A$		100	-	-	v	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2	3	3.5	v	
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, V_{GS} = ± 20 V	-	-	± 100	nA	
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 100 V	-	-	1		
Zero gate voltage drain current		$V_{GS} = 0 V$	V_{DS} = 100 V, T_J = 125 °C	-	-	50	μA	
		$V_{GS} = 0 V$	V_{DS} = 100 V, T_{J} = 175 °C	-	-	500		
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	50	-	-	Α	
		$V_{GS} = 10 V$	I _D = 20 A	-	0.0028	0.0036		
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 20 \text{ A}, T_J = 125 ^\circ\text{C}$	-	-	0.0074	Ω	
		$V_{GS} = 10 V$	$I_D = 20 \text{ A}, \text{T}_\text{J} = 175 \ ^\circ\text{C}$	-	-	0.0098		
Forward transconductance ^b	g _{fs}	V _{DS}	= 15 V, I _D = 25 A	-	100	-	S	
Dynamic ^b								
Input capacitance	Ciss		V _{GS} = 0 V V _{DS} = 25 V, f = 1 MHz	-	7213	10 099	pF	
Output capacitance	Coss	$V_{GS} = 0 V$		-	973	1445		
Reverse transfer capacitance	C _{rss}			-	54	84		
Total gate charge ^c	Qg	$\frac{Q_g}{Q_{gs}} \qquad V_{GS} = 10 \text{ V}$		-	122	186		
Gate-source charge ^c	Q _{gs}		$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 20 \text{ A}$	-	30	-	nC	
Gate-drain charge ^c	Q _{gd}			-	26	-		
Gate resistance	Rg	f = 1 MHz		0.4	1.1	2.2	Ω	
Turn-on delay time ^c	t _{d(on)}			-	17	27		
Rise time ^c	t _r	$V_{DD} = 50 \text{ V}, \text{ R}_{L} = 2.5 \Omega,$		-	16	26	ne	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 20 A$,	V_{GEN} = 10 V, R_g = 1 Ω	-	48	74	- ns	
Fall time ^c	t _f			-	13	20		
Source-Drain Diode Ratings and Charact	teristics ^b							
Pulsed current ^a	I _{SM}			-	-	388	Α	
Forward voltage	V _{SD}	$I_F = 40 \text{ A}, V_{GS} = 0 \text{ V}$		-	0.7	1.1	V	
Body diode reverse recovery time	t _{rr}	I _F = 15 A, di/dt = 100 A/μs		-	63	126	ns	
Body diode reverse recovery charge	Q _{rr}			-	151	302	nC	
Reverse recovery fall time	t _a			-	49	-	-	
Reverse recovery rise time	t _b			I	14	-	ns	
Body diode peak reverse recovery current	I _{RM(REC)}			-	-4.4	-	Α	
Notes								

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

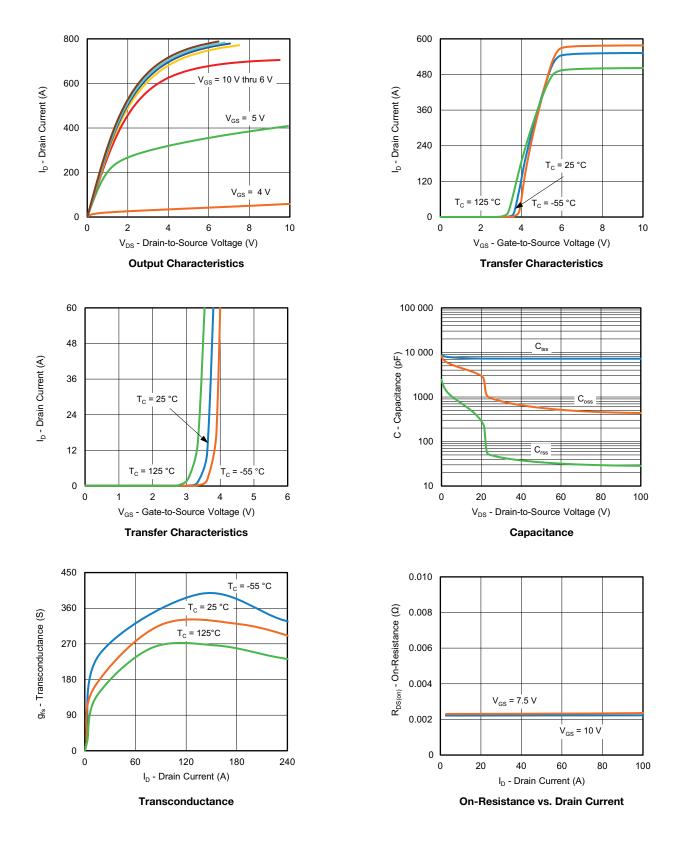
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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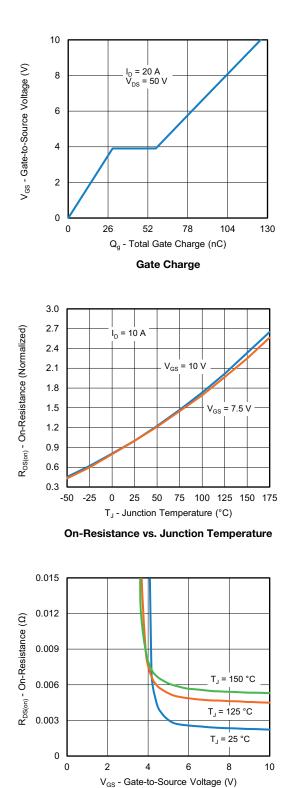
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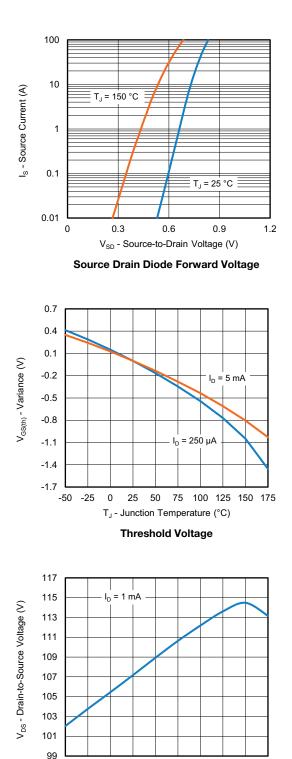


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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



On-Resistance vs. Gate-to-Source Voltage



T_J - Junction Temperature (°C) Drain Source Breakdown vs. Junction Temperature

-25

0 25 50

-50

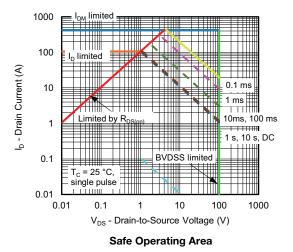
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Note

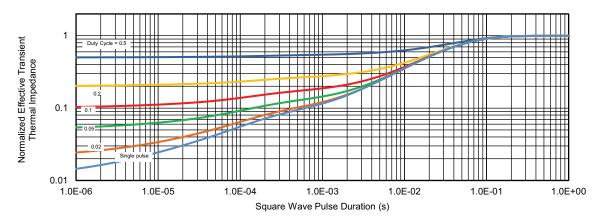
a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified



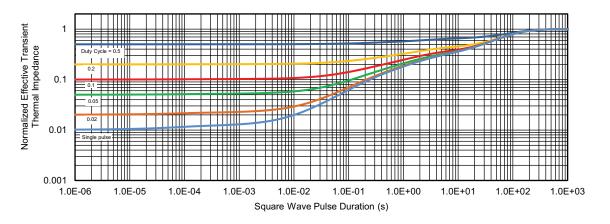
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case



Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62201.

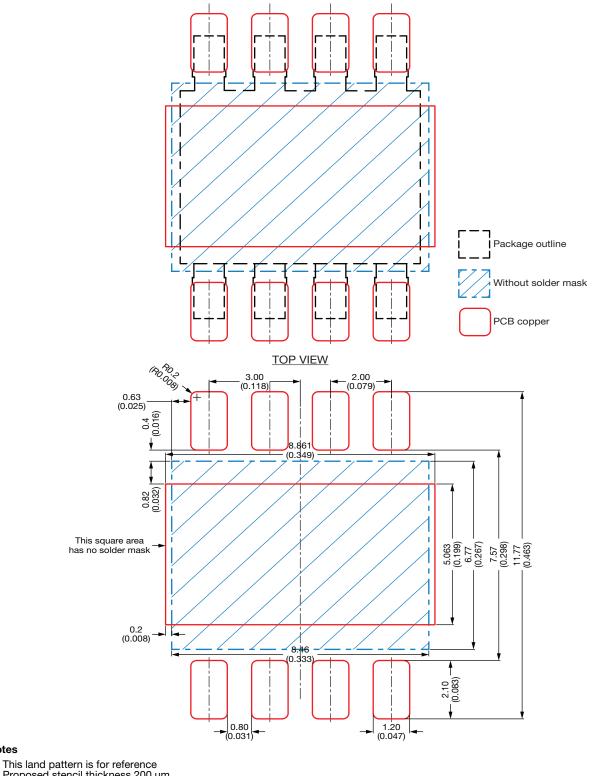
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PAD Pattern



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Recommended Land Pattern PowerPAK® 8 x 8LR



Proposed stencil thickness 200 µm All dimensions are in millimeter (inches)

ECN: C23-0461-Rev. B, 17-Apr-2023

DWG: 3002

Notes

Revision: 17-Apr-2023

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